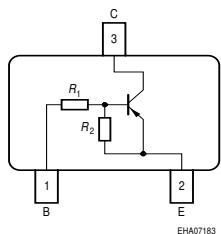
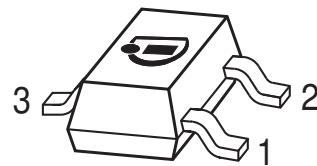


## PNP Silicon Digital Transistor

- Built in bias resistor ( $R_1 = 2.2 \text{ k}\Omega$ ,  $R_2 = 10 \text{ k}\Omega$ )
- Pb-free (RoHS compliant) package<sup>1)</sup>
- Qualified according AEC Q101



| Type   | Marking         | Pin Configuration |     |     | Package |
|--------|-----------------|-------------------|-----|-----|---------|
| BCR555 | XD <sub>S</sub> | 1=B               | 2=E | 3=C | SOT23   |

### Maximum Ratings

| Parameter  | Symbol            | Value       | Unit             |
|--|-------------------|-------------|------------------|
| Collector-emitter voltage  | $V_{CEO}$         | 50          | V                |
| Collector-base voltage   | $V_{CBO}$         | 50          |                  |
| Input forward voltage  | $V_i(\text{fwd})$ | 20          |                  |
| Input reverse voltage  | $V_i(\text{rev})$ | 5           |                  |
| Collector current  | $I_C$             | 500         | mA               |
| Total power dissipation-<br>$T_S \leq 79 \text{ }^\circ\text{C}$ | $P_{\text{tot}}$  | 330         | mW               |
| Junction temperature   | $T_j$             | 150         | $^\circ\text{C}$ |
| Storage temperature  | $T_{\text{stg}}$  | -65 ... 150 |                  |

### Thermal Resistance

| Parameter                                | Symbol            | Value      | Unit |
|--|-------------------|------------|------|
| Junction - soldering point <sup>2)</sup> | $R_{\text{thJS}}$ | $\leq 215$ | K/W  |

<sup>1</sup>Pb-containing package may be available upon special request

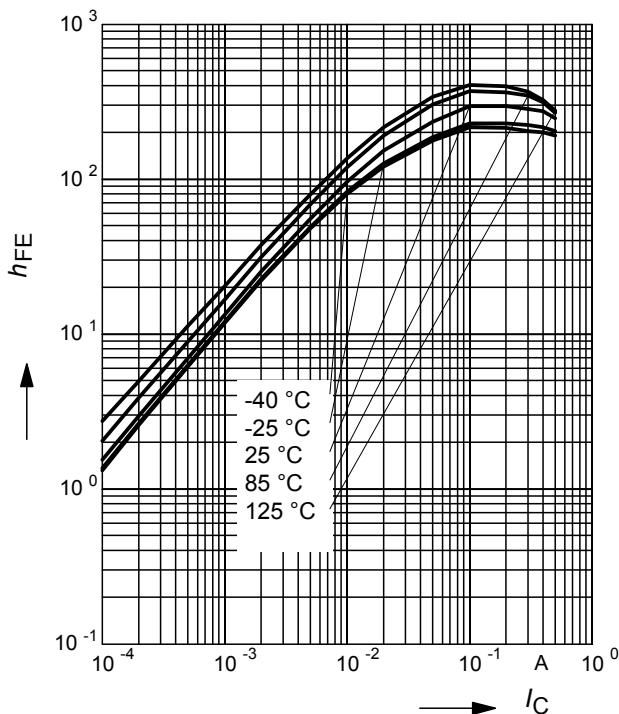
<sup>2</sup>For calculation of  $R_{\text{thJA}}$  please refer to Application Note Thermal Resistance

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

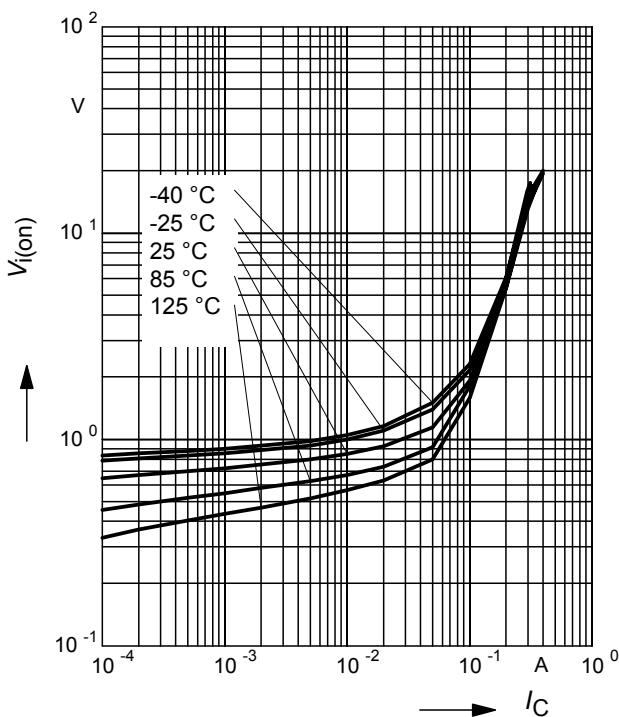
| Parameter   | Symbol                      | Values |      |      | Unit |
|---|-----------------------------|--------|------|------|------|
|   |                             | min.   | typ. | max. |      |
| <b>DC Characteristics</b>   |                             |        |      |      |      |
| Collector-emitter breakdown voltage<br>$I_C = 100 \mu\text{A}, I_B = 0$                           | $V_{(\text{BR})\text{CEO}}$ | 50     | -    | -    | V    |
| Collector-base breakdown voltage<br>$I_C = 10 \mu\text{A}, I_E = 0$                               | $V_{(\text{BR})\text{CBO}}$ | 50     | -    | -    |      |
| Collector-base cutoff current<br>$V_{CB} = 50 \text{ V}, I_E = 0$                                 | $I_{\text{CBO}}$            | -      | -    | 100  | nA   |
| Emitter-base cutoff current<br>$V_{EB} = 5 \text{ V}, I_C = 0$                                    | $I_{\text{EBO}}$            | -      | -    | 0.65 | mA   |
| DC current gain-<br>$I_C = 50 \text{ mA}, V_{CE} = 5 \text{ V}$                                   | $h_{\text{FE}}$             | 70     | -    | -    | -    |
| Collector-emitter saturation voltage <sup>1)</sup><br>$I_C = 50 \text{ mA}, I_B = 2.5 \text{ mA}$ | $V_{\text{CEsat}}$          | -      | -    | 0.3  | V    |
| Input off voltage<br>$I_C = 100 \mu\text{A}, V_{CE} = 5 \text{ V}$                                | $V_{i(\text{off})}$         | 0.4    | -    | 1    |      |
| Input on voltage<br>$I_C = 10 \text{ mA}, V_{CE} = 0.3 \text{ V}$                                 | $V_{i(\text{on})}$          | 0.5    | -    | 1.4  |      |
| Input resistor  | $R_1$                       | 1.5    | 2.2  | 2.9  | kΩ   |
| Resistor ratio  | $R_1/R_2$                   | 0.19   | 0.22 | 0.24 | -    |
| <b>AC Characteristics</b>   |                             |        |      |      |      |
| Transition frequency<br>$I_C = 50 \text{ mA}, V_{CE} = 5 \text{ V}, f = 100 \text{ MHz}$          | $f_T$                       | -      | 150  | -    | MHz  |

<sup>1)</sup>Pulse test:  $t < 300\mu\text{s}$ ;  $D < 2\%$

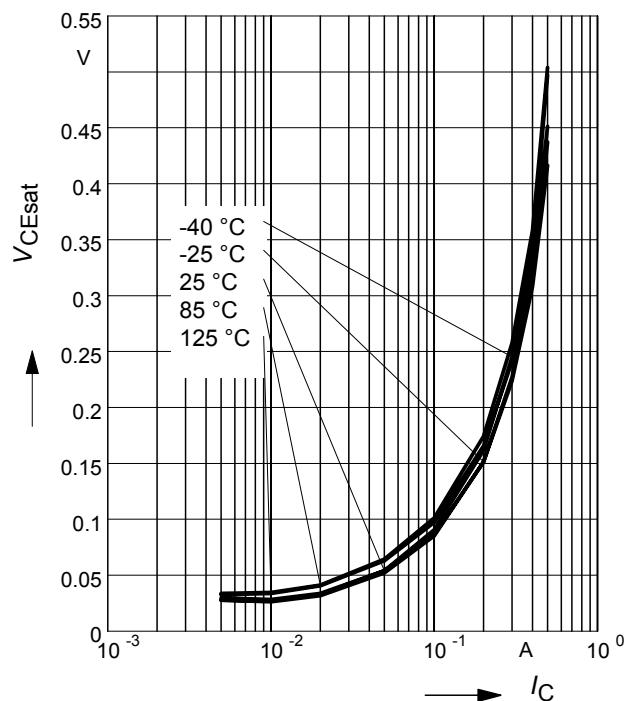
**DC current gain  $h_{FE} = f(I_C)$**   
 $V_{CE} = 5 \text{ V}$  (common emitter configuration)



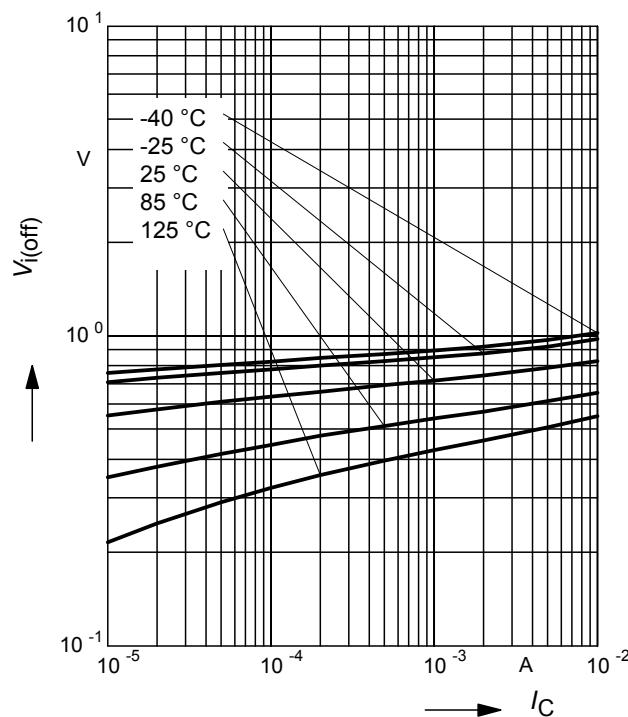
**Input on Voltage  $V_{i(on)} = f(I_C)$**   
 $V_{CE} = 0.3 \text{ V}$  (common emitter configuration)



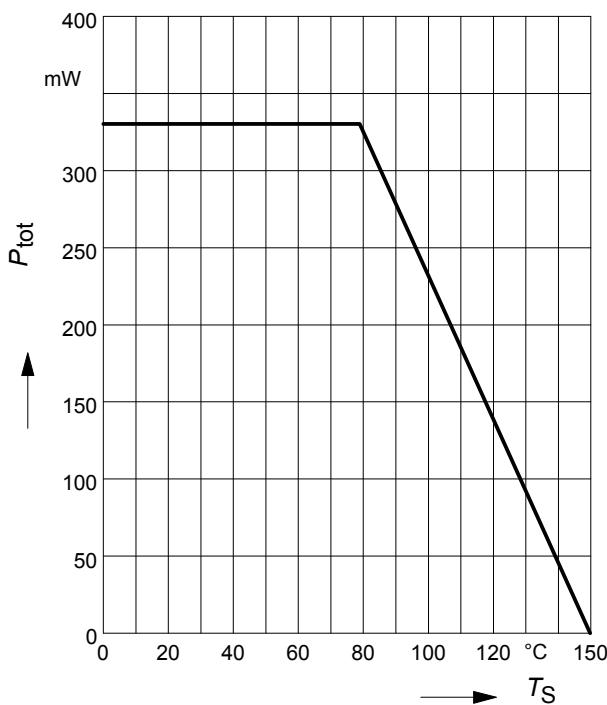
**Collector-emitter saturation voltage**  
 $V_{CEsat} = f(I_C)$ ,  $I_C/I_B = 20$



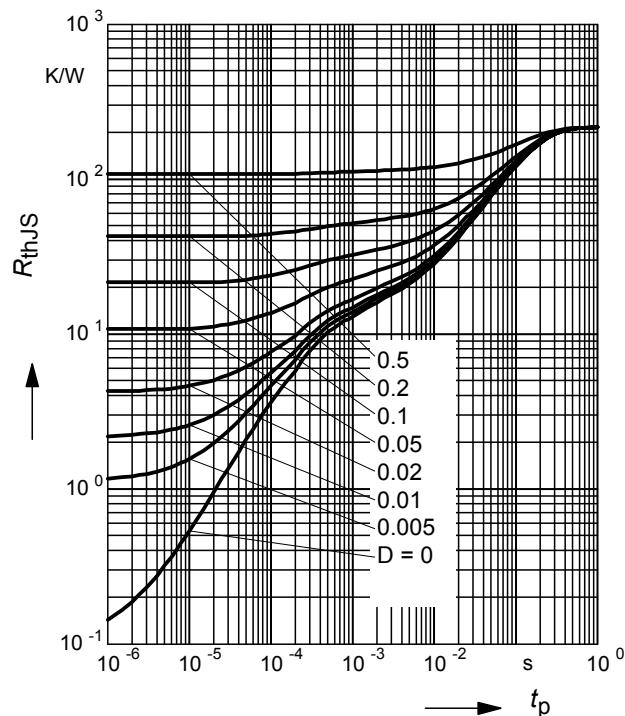
**Input off voltage  $V_{i(off)} = f(I_C)$**   
 $V_{CE} = 5 \text{ V}$  (common emitter configuration)



**Total power dissipation**  $P_{\text{tot}} = f(T_S)$

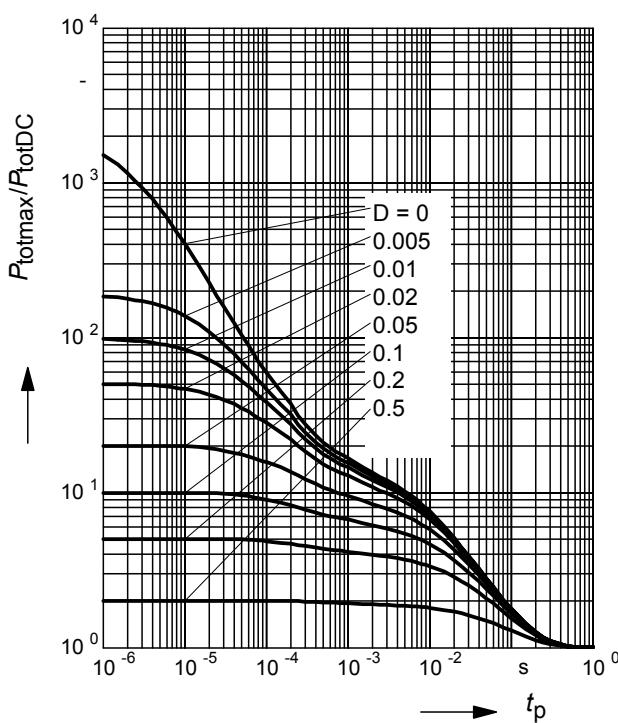


**Permissible Pulse Load**  $R_{\text{thJS}} = f(t_p)$

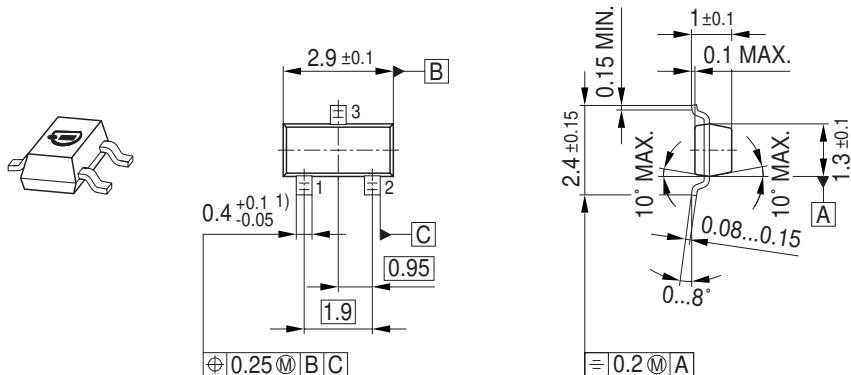


**Permissible Pulse Load**

$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$

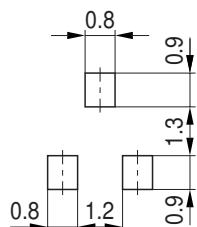


## Package Outline

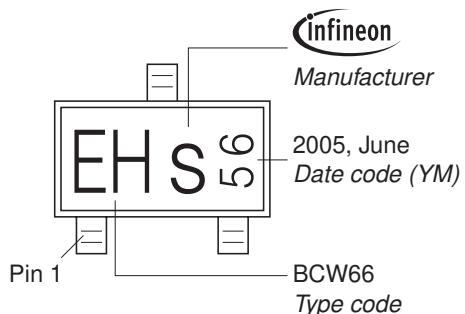


1) Lead width can be 0.6 max. in dambar area

## Foot Print

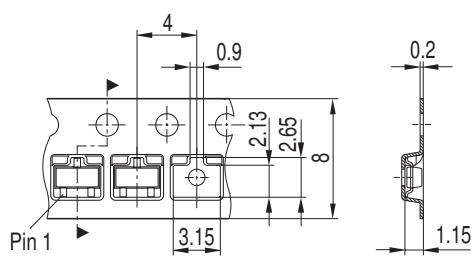


## Marking Layout (Example)



## Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel  
Reel ø330 mm = 10.000 Pieces/Reel



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